

## Lead-Free Solder Paste

### ◆ Product Description

This lead-free solder paste is SAC305 alloy with INDIUM8.9HF flux, TYPE4 particle size and 500g packaging, featuring good wetting, full and firm solder joints for precision electronic SMT soldering.



### ◆ Product Advantages

- Lead-Free And Eco-Friendly, Compliant With International Environmental Standards
- SAC305 Alloy, Firm Solder Joints And Strong Stability
- TYPE4 Particle Size, Suitable For Precision Component SMT Soldering
- INDIUM8.9HF Flux, Excellent Wettability For Soldering
- 500G Large Capacity, Suitable For Batch Production

### ◆ Product Structure

It is a uniform mixture of alloy powder and flux, with uniform TYPE4 particle size, high-activity INDIUM8.9HF flux and 500g sealed packaging for stable structure and balanced soldering performance.

### ◆ Application Scenarios

Suitable for SMT soldering of precision electronics like mobile phones, computers and industrial control boards, compliant with environmental standards for high-precision soldering.

### ◆ Technical Features

Main Alloy: SAC305 Lead-Free Material

Flux Component: INDIUM8.9HF

Particle Size Specification: TYPE4 Requirements

Soldering Performance: Full Solder Joints

Storage Performance: Sealed Packaging

Item#	Model	Weight	Packaging
1.5.19.03.0041	SAC305	0.5kg	500g/pcs

### ◆ Remarks

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